74AXP1G14 Low-power Schmitt trigger inverter Rev. 1 – 28 August 2014

Product data sheet

1. General description

The 74AXP1G14 is a single inverter with Schmitt trigger input. It transforms slowly changing input signals into sharply defined, jitter-free output signals.

This device ensures very low static and dynamic power consumption across the entire V_{CC} range from 0.7 V to 2.75 V. It is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.7 V to 2.75 V
- Low input capacitance; C_I = 0.5 pF (typical)
- Low output capacitance; C_O = 1.0 pF (typical)
- Low dynamic power consumption; C_{PD} = 2.4 pF at V_{CC} = 1.2 V (typical)
- Low static power consumption; I_{CC} = 0.6 μA (85 °C maximum)
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-12A.01 (1.1 V to 1.3 V)
 - JESD8-11A.01 (1.4 V to 1.6 V)
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A.01 (2.3 V to 2.7 V)
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2 kV
 - CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 2.75 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C



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3. Ordering information

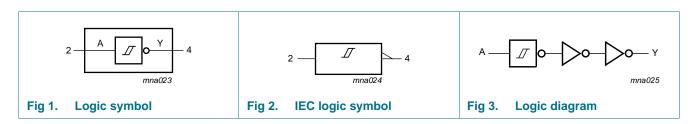
Type number	Package							
	Temperature range	Name	Description	Version				
74AXP1G14GM	–40 °C to +85 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				
74AXP1G14GN	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115				
74AXP1G14GS	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202				
74AXP1G14GX	–40 °C to +85 °C	X2SON5	X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm	SOT1226				

4. Marking

Table 2. Marking	
Type number	Marking code ^[1]
74AXP1G14GM	rF
74AXP1G14GN	rF
74AXP1G14GS	rF
74AXP1G14GX	rF

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

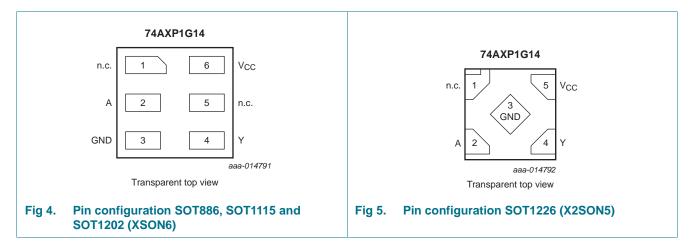


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6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description					
Symbol	Pin	Pin			
	X2SON5	XSON6			
n.c.	1	1	not connected		
A	2	2	data input		
GND	3	3	ground (0 V)		
Y	4	4	data output		
n.c.	-	5	not connected		
V _{CC}	5	6	supply voltage		

7. Functional description

Table 4. Function table^[1]

Input	Output
A	Y
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+3.3	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		[1] -0.5	+3.3	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage		[1] -0.5	+3.3	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±20	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		0.7	2.75	V
VI	input voltage		0	2.75	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	2.75	V
T _{amb}	ambient temperature		-40	+85	°C

10. Static characteristics

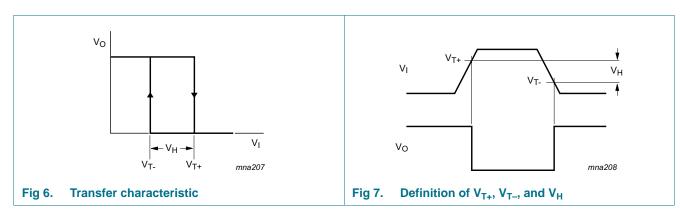
Table 7. Static characteristics

At recommended operating conditions, unless otherwise specified; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		T _{amb} = -40 °C to +85 °C				
				Min	Typ 25 °C	Max 25 °C	Max 85 °C	
V _{T+}	positive-going	see Figure 6 and Figure 7		1				
	threshold voltage	$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$		$0.3V_{CC}$	-	0.8V _{CC}	0.8V _{CC}	V
		V _{CC} = 1.1 V to 1.95 V		$0.4V_{CC}$	-	0.7V _{CC}	0.7V _{CC}	V
		V_{CC} = 2.3 V to 2.7 V		0.9	-	1.7	1.7	V
V _{T-}	negative-going	see Figure 6 and Figure 7				l	1	
	threshold voltage	$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$		$0.2V_{CC}$	-	0.7V _{CC}	0.7V _{CC}	V
		V _{CC} = 1.1 V to 1.95 V		0.3V _{CC}	-	0.6V _{CC}	0.6V _{CC}	V
		V_{CC} = 2.3 V to 2.7 V		0.7	-	1.5	1.5	V
V _H	hysteresis	see Figure 6 and Figure 7						
	voltage	$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$		0.06V _{CC}	-	0.5V _{CC}	$0.5V_{CC}$	V
		V _{CC} = 1.1 V to 1.95 V		0.1V _{CC}	-	0.4V _{CC}	0.4V _{CC}	V
		V_{CC} = 2.3 V to 2.7 V		0.2	-	1.0	1.0	V
V _{OH}	OH HIGH-level	$I_0 = -20 \ \mu A; V_{CC} = 0.7 \ V$		-	0.69	-	-	V
output voltage	$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 0.75 \ \text{V}$		0.65	-	-	-	V	
		$I_0 = -2 \text{ mA}; V_{CC} = 1.1 \text{ V}$		0.825	-	-	-	V
		$I_0 = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$		1.05	-	-	-	V
		$I_{O} = -4.5 \text{ mA}; V_{CC} = 1.65 \text{ V}$		1.2	-	-	-	V
		$I_0 = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		1.7	-	-	-	V
V _{OL}	LOW-level	$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 0.7 \ \text{V}$		-	0.01	-	-	V
	output voltage	$I_0 = 100 \ \mu A; \ V_{CC} = 0.75 \ V$		-	-	0.1	0.1	V
		I _O = 2 mA; V _{CC} = 1.1 V		-	-	0.275	0.275	V
		I _O = 3 mA; V _{CC} = 1.4 V		-	-	0.35	0.35	V
		I _O = 4.5 mA; V _{CC} = 1.65 V		-	-	0.45	0.45	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.7	0.7	V
I	input leakage current	V _I = 0 V to 2.75 V; V _{CC} = 0 V to 2.75 V	<u>[1]</u>	-	0.001	±0.1	±0.5	μA
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 0$ V to 2.75 V; $V_{CC} = 0$ V	<u>[1]</u>	-	0.01	±0.1	±0.5	μΑ
∆l _{off}	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V or } 2.75 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.1 \text{ V}$	[1]	-	0.02	±0.1	±0.5	μA
lcc	supply current	$V_I = 0 V \text{ or } V_{CC}; I_O = 0 A$	<u>[1]</u>	-	0.01	0.3	0.6	μΑ
Δl _{CC}	additional supply current			-	2	100	150	μA

[1] Typical values are measured at V_{CC} = 1.2 V.

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10.1 Waveform transfer characteristics

11. Dynamic characteristics

Table 8.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see <u>Figure 14</u>.

Symbol	Parameter	Conditions	Τ _ε	amb = 25 °	°C	T _{amb} = -4	40 °C to +85 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	A to Y; see Figure 8 [2][3]						
		$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$	3	12	35	2	114	ns
		V _{CC} = 1.1 V to 1.3 V	2.0	4.6	7.2	1.8	7.5	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	1.6	3.5	5.0	1.4	5.3	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.4	2.9	4.1	1.2	4.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.2	2.3	3.2	1.0	3.5	ns
t _t	transition time	$V_{CC} = 2.7 \text{ V}; \text{ see } \underline{\text{Figure 8}}$ [4]	-	-	-	1.0	-	ns
CI	input capacitance	$V_{I} = 0 V \text{ or } V_{CC};$ $V_{CC} = 0 V \text{ to } 2.75 V$		0.5	-	-	-	pF
Co	output capacitance	$V_{O} = 0 V; V_{CC} = 0 V$	-	1.0	-	-	-	pF
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_1 = 0 \text{ V to } V_{CC}$ [5]	1		1			
	capacitance	$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$	-	2.3	-	-	-	pF
	V _{CC} = 1.1 V to 1.3 V	-	2.4	-	-	-	pF	
	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	2.5	-	-	-	pF	
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	2.6	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	3.0	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.

- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] For additional propagation delay values at different load capacitances, see Figure 9 to Figure 13.
- [4] t_t is the same as t_{THL} and t_{TLH} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 - $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + C_{L} \times V_{CC}^{2} \times f_{o} \text{ where:}$

 f_i = input frequency in MHz;

- f_o = output frequency in MHz;
- C_L = output load capacitance in pF;
- V_{CC} = supply voltage in V;

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N = number of inputs switching.

12. Waveforms

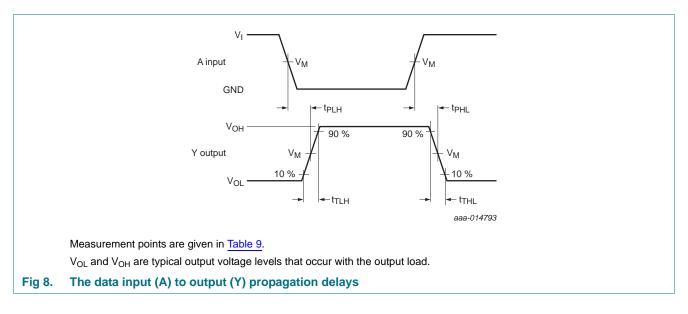
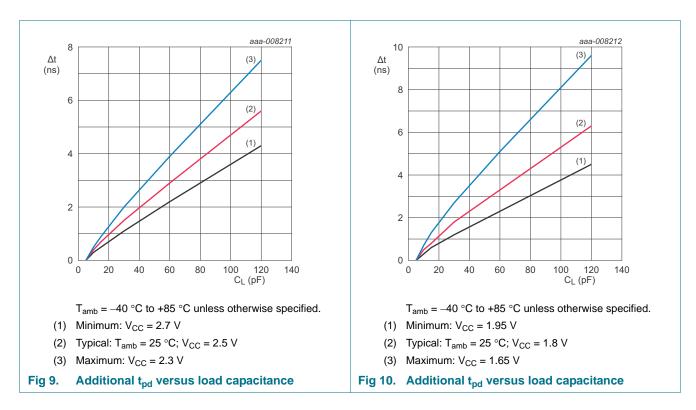


Table 9. Measurement points

Supply voltage	Input			Output
V _{CC}	V _M	VI	$t_r = t_f$	V _M
0.75 V to 2.7 V	0.5V _{CC}	V _{CC}	≤ 3.0 ns	0.5V _{CC}

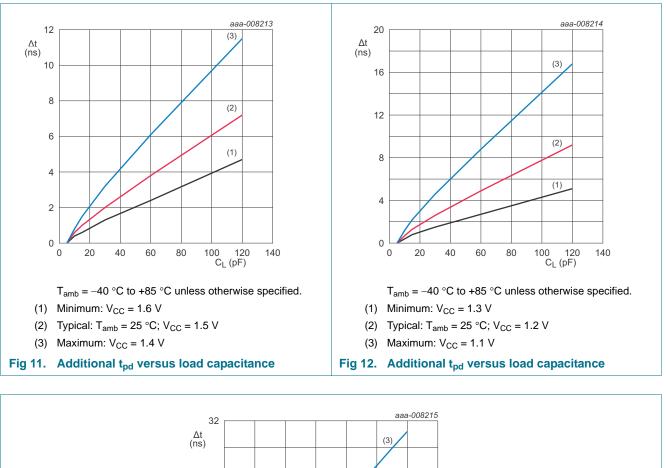


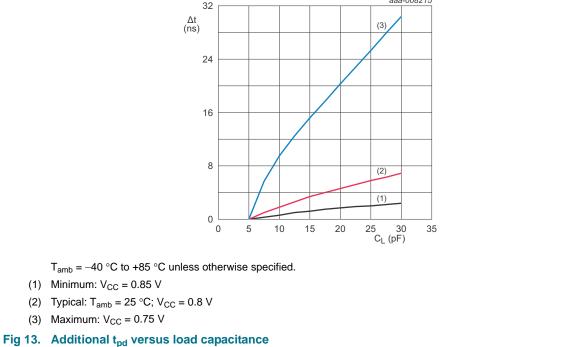
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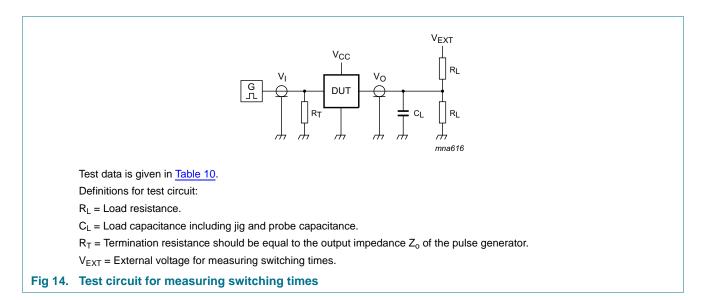


Table 10. Test data

Supply voltage	Load		V _{EXT}		
V _{cc}	C _L R _L		t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.75 V to 2.7 V	5 pF	10 kΩ	0 V	0 V	$2 \times V_{CC}$

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13. Package outline

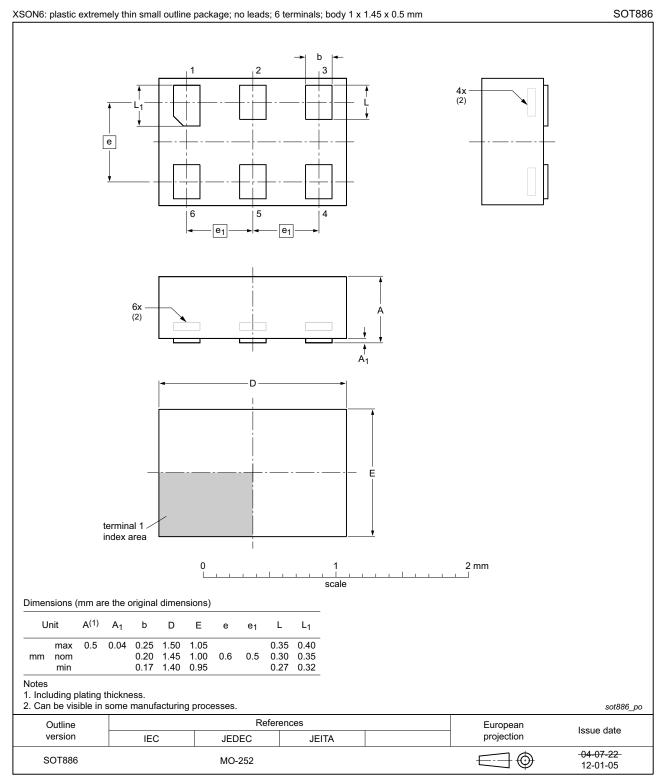
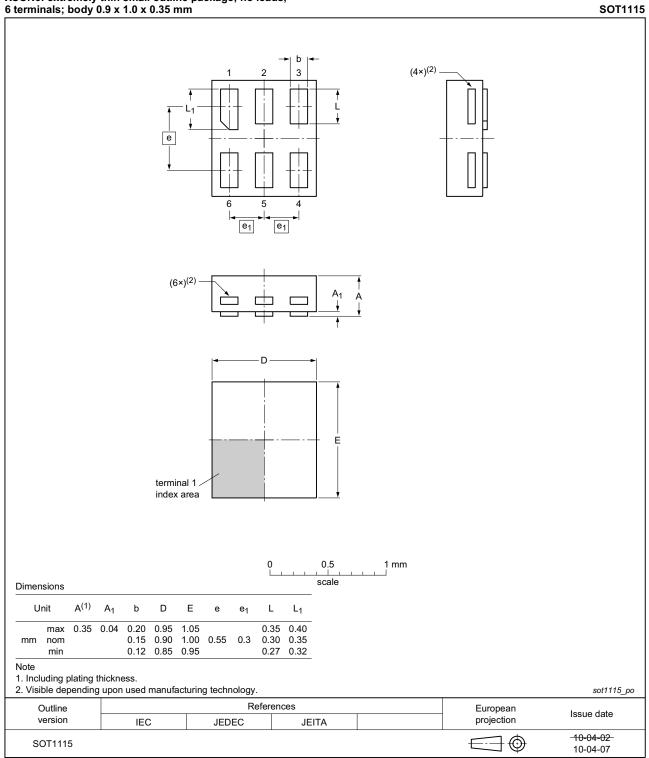


Fig 15. Package outline SOT886 (XSON6)

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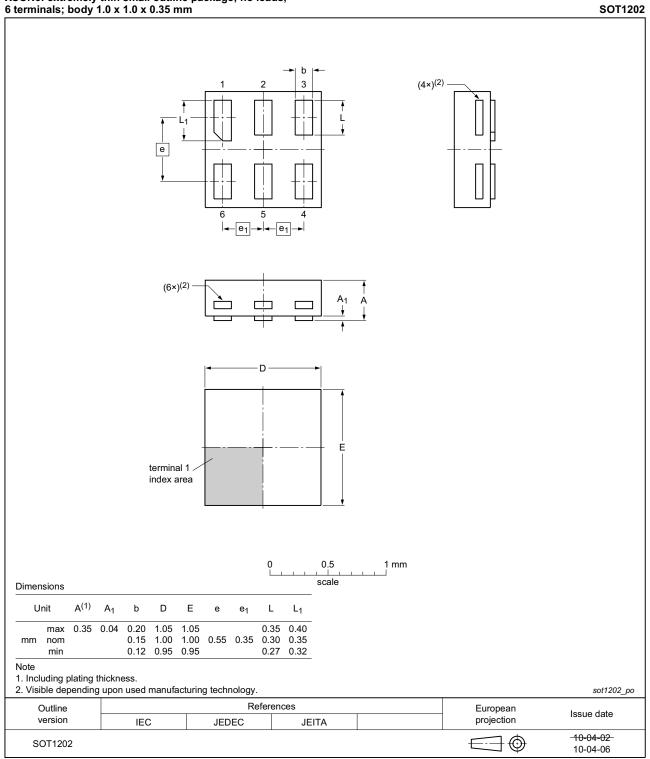


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 16. Package outline SOT1115 (XSON6)

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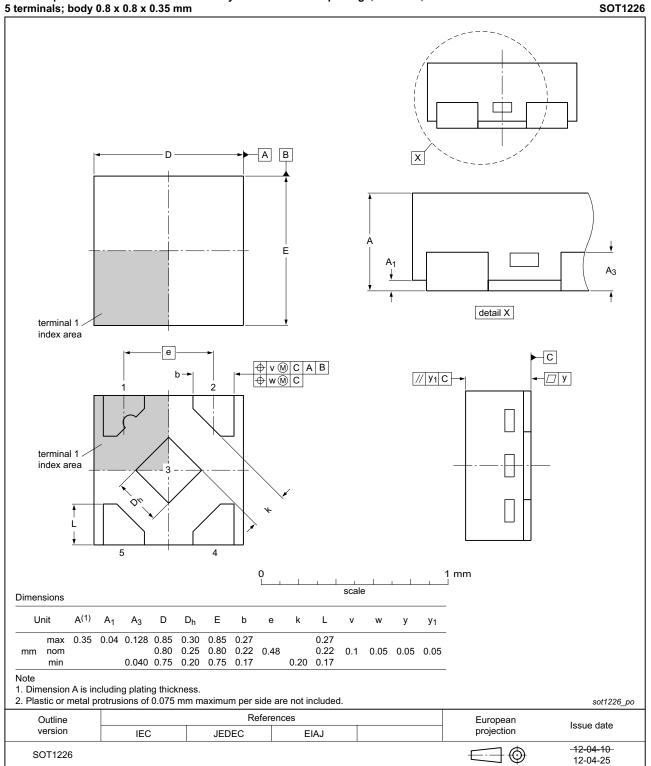


XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 17. Package outline SOT1202 (XSON6)

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X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals: body 0.8 x 0.8 x 0.35 mm

Fig 18. Package outline SOT1226 (X2SON5)

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14. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			

15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AXP1G14 v.1	20140828	Product data sheet	-	-

16. Legal information

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